BGA Heat Sink - High Performance ASIC Cooling





ATS Part#: ATS-56001-C4-R0

Description: 19.00 x 19.00 x 9.00 mm BGA Heat Sink - High Performance ASIC Cooling

Heat Sink Type: ASIC Cooling
Heat Sink Attachment: Thermal Tape

Equivalent Part Number: N/A

*Image above is for illustration purpose only.

Features & Benefits

- maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- · Designed specifically for ASIC package and their unique cooling requirements

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	5.3 °C/W	4.1 °C/W	3.4 °C/W	3 °C/W	2.7 °C/W	2.4 °C/W	2.2 °C/W
	Ducted Flow	3.3	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail



